

KBP200 Thru 2010

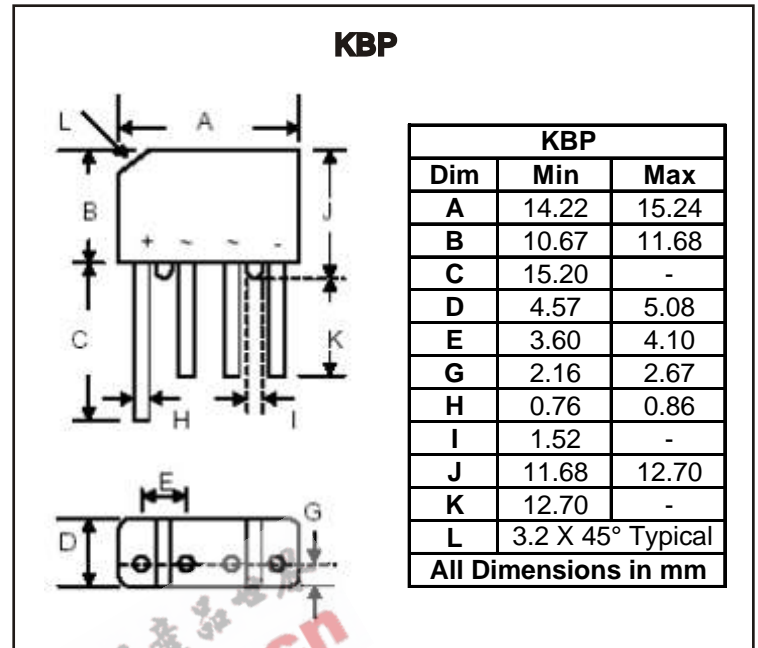
Reverse Voltage: 50 - 1000 Volts
Forward Current: 2.0 Amp

Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Weight: 1.7 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



Maximum Ratings and Electrical Characteristics

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

| CHARACTERISTICS | Symbol | KBP 200 | KBP 201 | KBP 202 | KBP 204 | KBP 206 | KBP 208 | KBP 2010 | UNIT |
|--|----------------|-------------|---------|---------|---------|---------|---------|----------|----------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | | | | | | | | |
| Working Peak Reverse Voltage | V_{RWM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| DC Blocking Voltage | V_R | | | | | | | | |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ $T_A = 50^\circ\text{C}$ (Note 1) | I_O | 2.0 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rate load (JEDEC Method) | I_{FSM} | 60 | | | | | | | A |
| Forward Voltage (per element) @ $I_F = 2.0\text{A}$ | V_{FM} | 1.1 | | | | | | | V |
| Peak Reverse Current @ $T_A = 25^\circ\text{C}$ | I_{RM} | 10 | | | | | | | uA |
| At Rated DC Blocking Voltage @ $T_A = 100^\circ\text{C}$ | | 500 | | | | | | | |
| Rating for Fusing ($t < 8.3\text{ms}$) | I^2t | 15 | | | | | | | A^2s |
| Typical Junction Capacitance per element (Note 2) | C_j | 25 | | | | | | | pF |
| Typical Thermal Resistance (Note 3) | R_{JA} | 30 | | | | | | | K/W |
| Operating and Storage Temperature Range | T_j, T_{STG} | -55 to +160 | | | | | | | $^\circ\text{C}$ |

- Note:**
1. Leads maintained at ambient temperature at a distance of 9.5mm from the case.
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.
 3. Thermal resistance junction to ambient mounted on PC board with 12mm^2 copper pad.

Rating and Characteristic Curves (KBP200 - KBP2010)

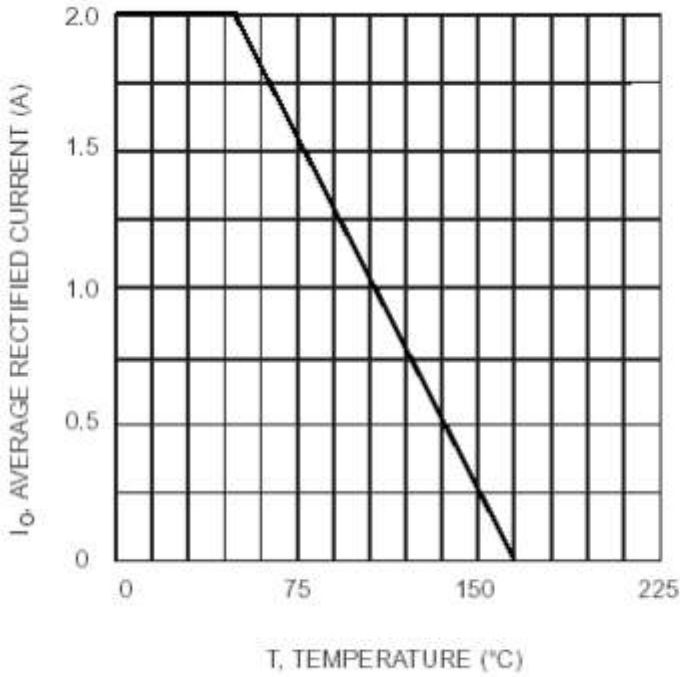


Fig. 1 Forward Current Derating Curve

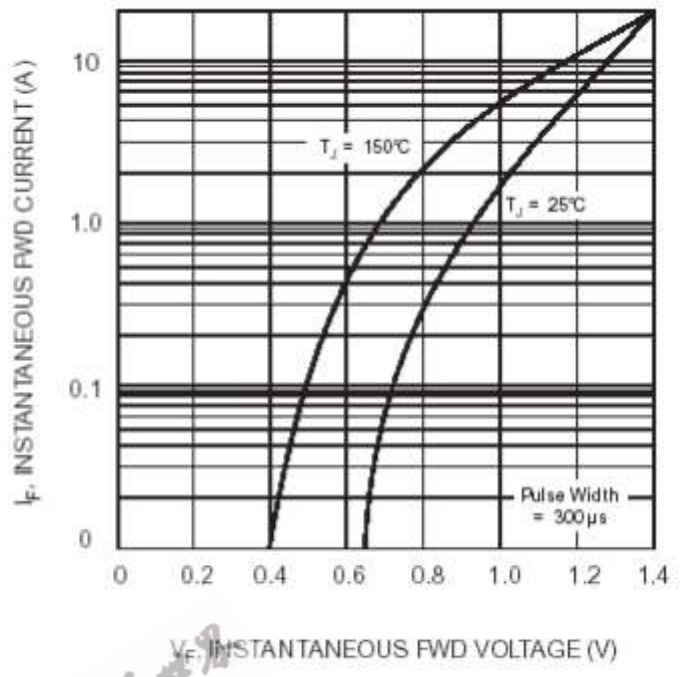


Fig. 2 Typical Fwd Characteristics

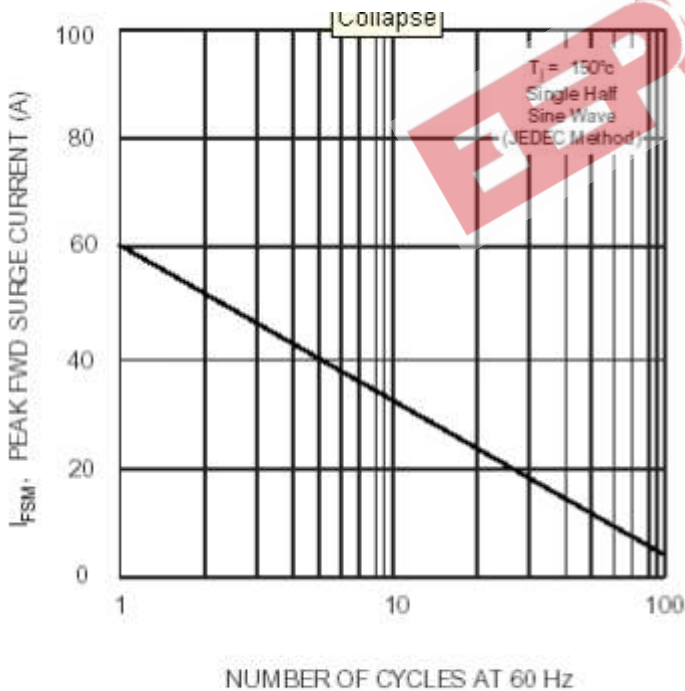


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

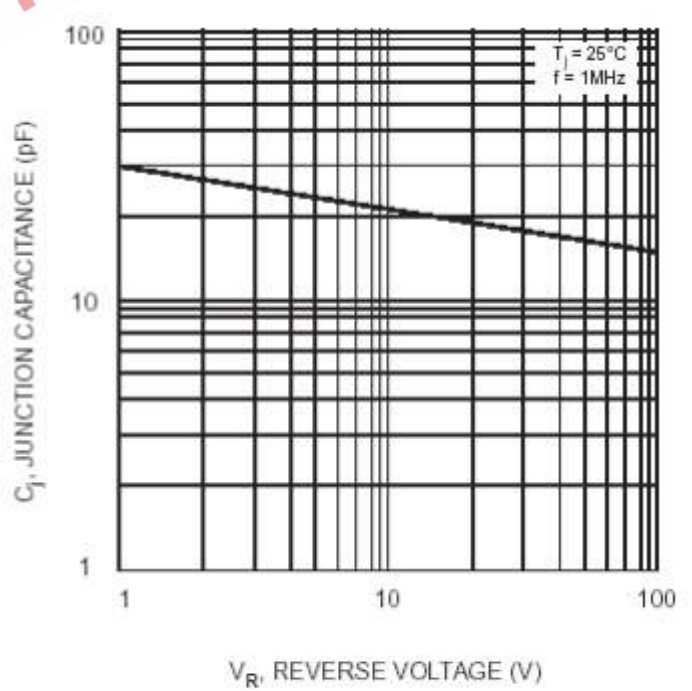


Fig. 4 Typical Junction Capacitance

Rating and Characteristic Curves (KBP200 - KBP2010)

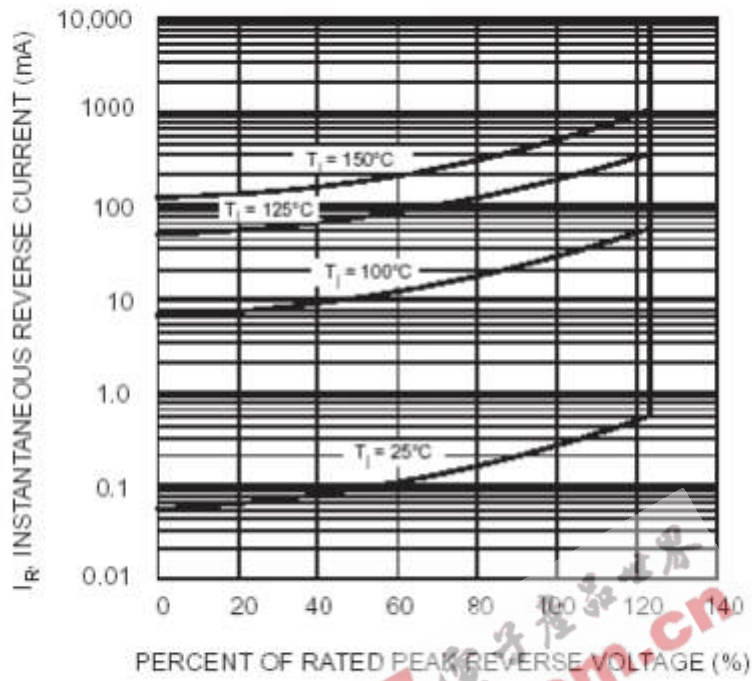


Fig. 5 Typical Reverse Characteristics